



SPN3402

N-Channel Enhancement Mode MOSFET

DESCRIPTION

The SPN3402 is the N-Channel logic enhancement mode power field effect transistors are produced using high cell density , DMOS trench technology.

This high density process is especially tailored to minimize on-state resistance.

These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management and other battery powered circuits, and low in-line power loss are needed in a very small outline surface mount package.

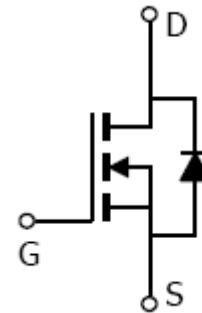
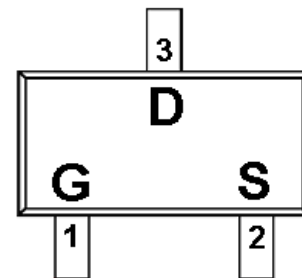
FEATURES

- ◆ 30V/2.8A, $R_{DS(ON)}=58m\Omega@V_{GS}=10V$
- ◆ 30V/2.3A, $R_{DS(ON)}=65m\Omega@V_{GS}=4.5V$
- ◆ 30V/1.5A, $R_{DS(ON)}=105m\Omega@V_{GS}=2.5V$
- ◆ Super high density cell design for extremely low $R_{DS(ON)}$
- ◆ Exceptional on-resistance and maximum DC current capability
- ◆ SOT-23-3L package design

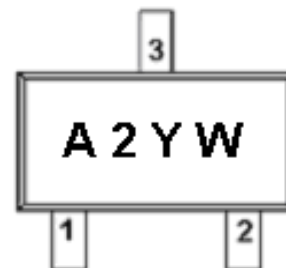
APPLICATIONS

- Power Management in Note book
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch
- DSC
- LCD Display inverter

PIN CONFIGURATION (SOT-23-3L)



PART MARKING



Y : Year Code
W : Week Code



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PIN DESCRIPTION

Pin	Symbol	Description
1	G	Gate
2	S	Source
3	D	Drain

ORDERING INFORMATION

Part Number	Package	Part Marking
SPN3402S23RGB	SOT-23-3L	A2

※ Week Code : A ~ Z (1 ~ 26) ; a ~ z (27 ~ 52)

※ SPN3402S23RGB : Tape Reel ; Pb – Free; Halogen - Free

ABSOLUTE MAXIMUM RATINGS

(TA=25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V _{DSS}	30	V
Gate –Source Voltage	V _{GSS}	±12	V
Continuous Drain Current(T _J =150°C)	I _D	TA=25°C	4.0
		TA=70°C	2.8
Pulsed Drain Current	I _{DM}	10	A
Continuous Source Current(Diode Conduction)	I _S	1.25	A
Power Dissipation	P _D	TA=25°C	1.25
		TA=70°C	0.8
Operating Junction Temperature	T _J	150	°C
Storage Temperature Range	T _{STG}	-55/150	°C
Thermal Resistance-Junction to Ambient	R _{θJA}	100	°C/W



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ELECTRICAL CHARACTERISTICS

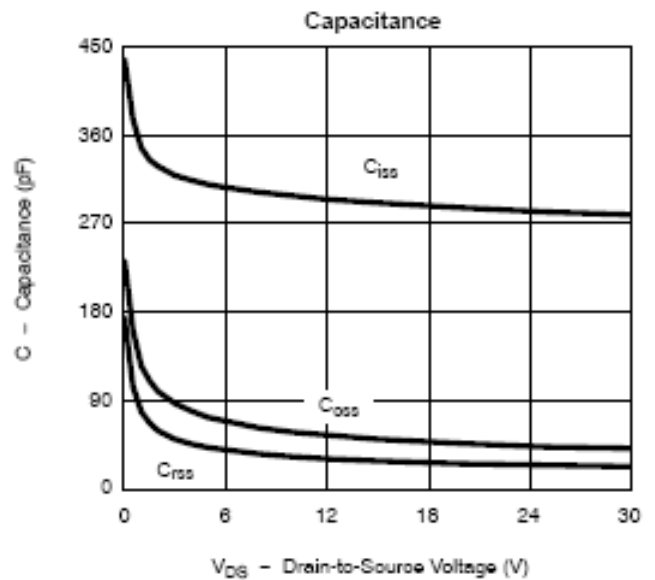
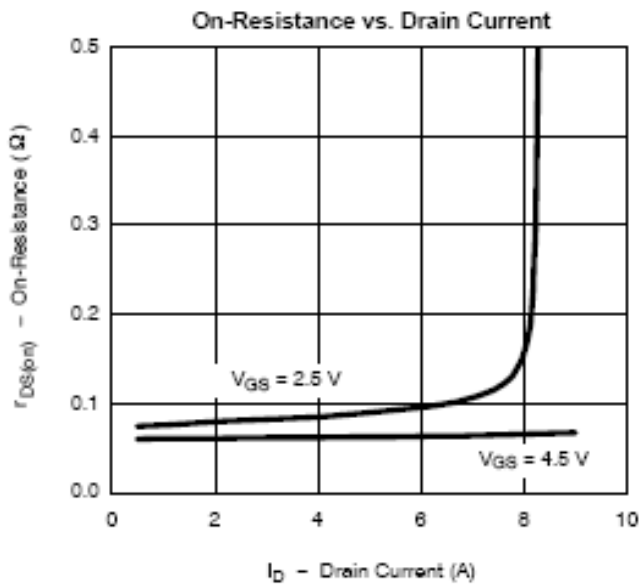
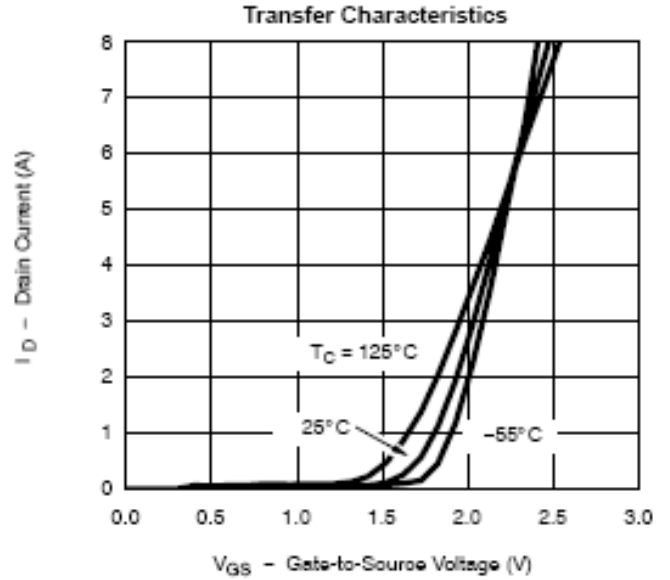
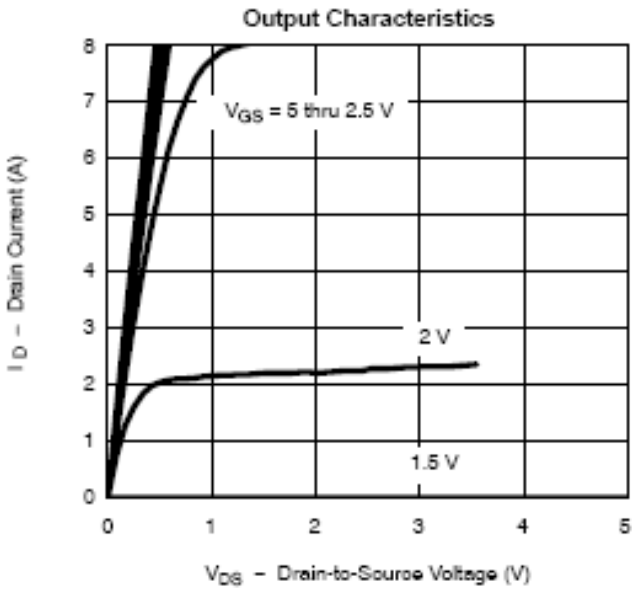
(TA=25°C Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=250\mu A$	30			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	0.5		1.6	
Gate Leakage Current	I_{GSS}	$V_{DS}=0V, V_{GS}=\pm 12V$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=24V, V_{GS}=0.0V$			1	uA
		$V_{DS}=24V, V_{GS}=0.0V$ $T_J=55^\circ C$			10	
On-State Drain Current	$I_{D(on)}$	$V_{DS} \geq 4.5V, V_{GS}=10V$	6			A
		$V_{DS} \geq 4.5V, V_{GS}=4.5V$	4			
Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS} = 10V, I_D=2.8A$		0.048	0.058	Ω
		$V_{GS} = 4.5V, I_D=2.3A$		0.053	0.065	
		$V_{GS} = 2.5V, I_D=1.5A$		0.080	0.105	
Forward Transconductance	g_{fs}	$V_{DS}=4.5V, I_D=2.8A$		4.6		S
Diode Forward Voltage	V_{SD}	$I_S=1.25A, V_{GS}=0V$		0.82	1.2	V
Dynamic						
Total Gate Charge	Q_g	$V_{DS}=15, V_{GS}=4.5V$ $I_D=2.0A$		4.2	6	nC
Gate-Source Charge	Q_{gs}			0.6		
Gate-Drain Charge	Q_{gd}			1.5		
Input Capacitance	C_{iss}	$V_{DS}=15, V_{GS}=0V$ $f = 1MHz$		350		pF
Output Capacitance	C_{oss}			55		
Reverse Transfer Capacitance	C_{rss}			41		
Turn-On Time	$t_{d(on)}$	$V_{DD}=15, R_L=10\Omega$ $V_{GEN}=10V, R_G=3\Omega$		2.5		nS
	t_r			2.5		
Turn-Off Time	$t_{d(off)}$			20		
	t_f			4		



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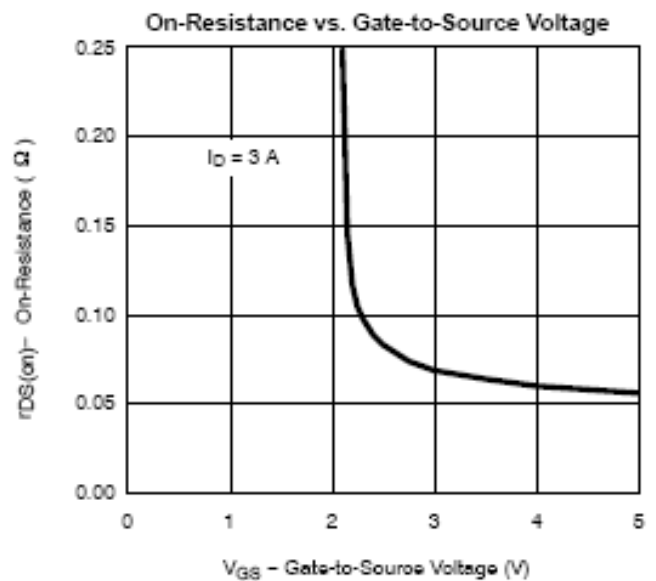
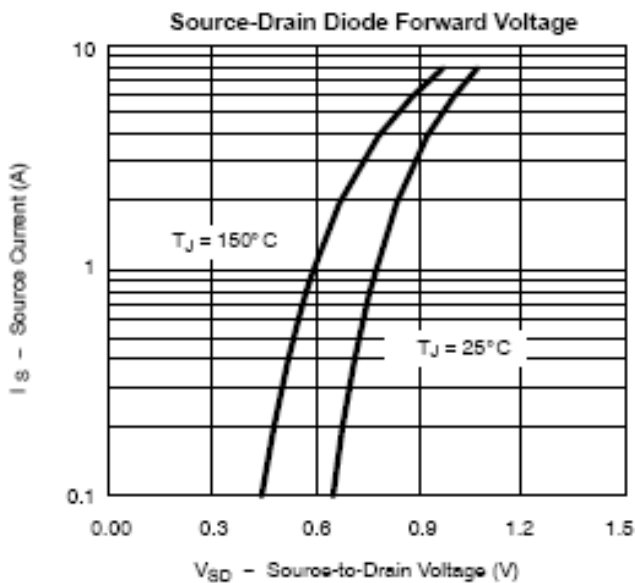
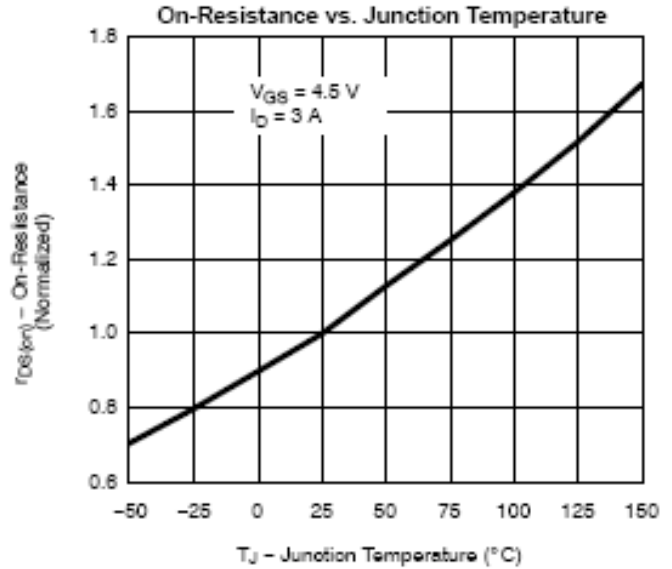
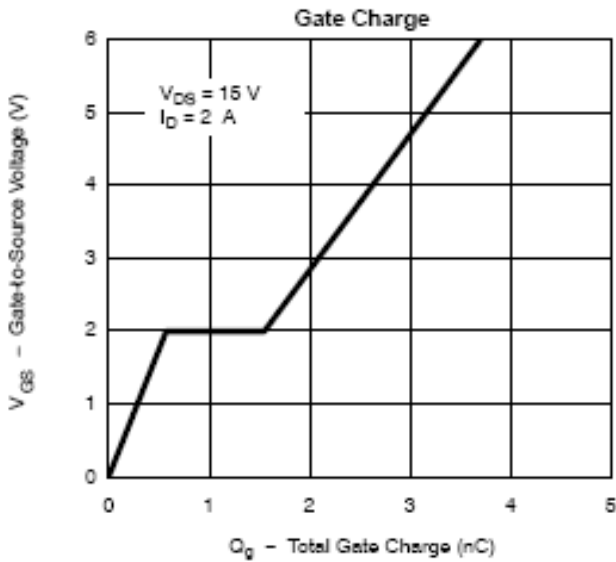
TYPICAL CHARACTERISTICS





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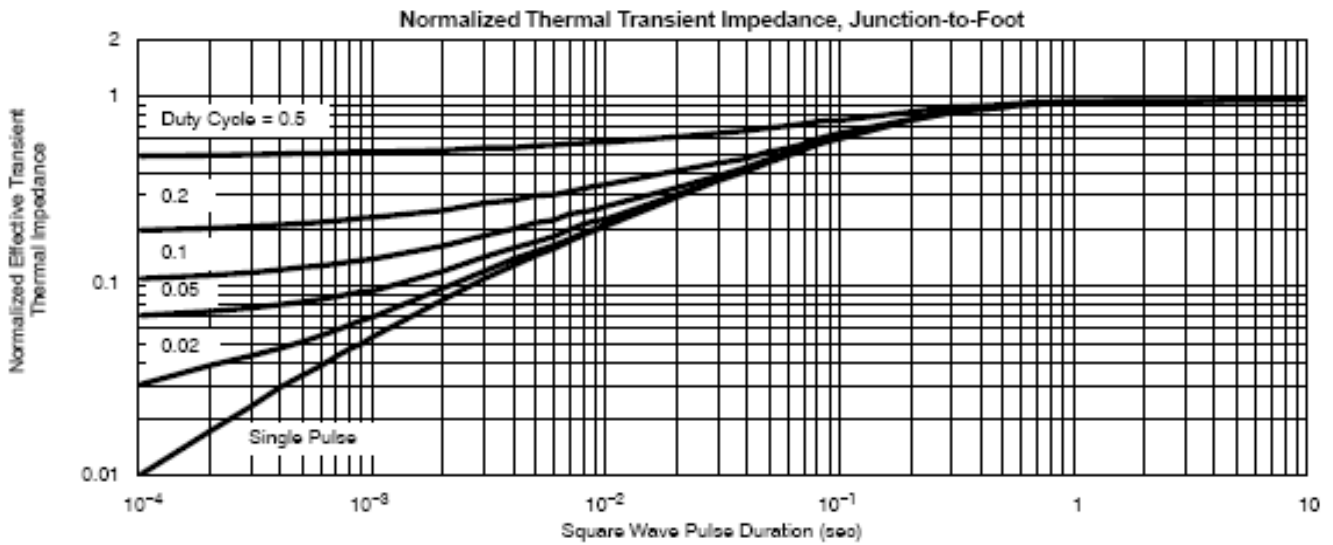
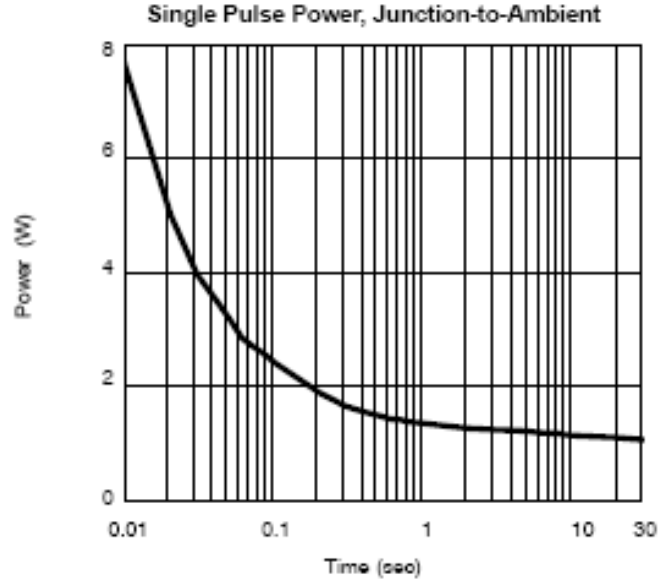
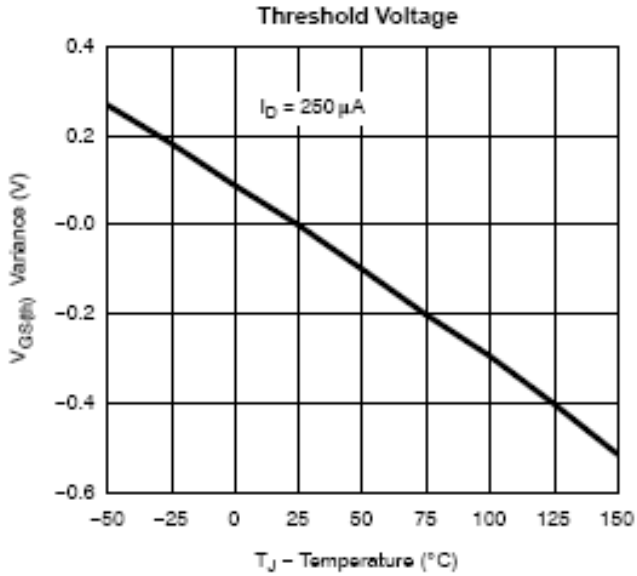
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TYPICAL CHARACTERISTICS





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SYNC Power Corporation

7F-2, No.3-1, Park Street

NanKang District (NKSP), Taipei, Taiwan, 115, R.O.C

Phone: 886-2-2655-8178

Fax: 886-2-2655-8468

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